

HALOGEN FREE



PowerPAK SC-70-6 Dual

2.05 mm

Vishay Siliconix

Dual P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY								
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A)	Q _g (Typ.)					
- 12	0.041 at $V_{GS} = -4.5 \text{ V}$	- 4.5 ^a						
	0.060 at V _{GS} = - 2.5 V	- 4.5 ^a	10.5 nC					
	0.110 at V _{GS} = - 1.8 V	- 3.5						

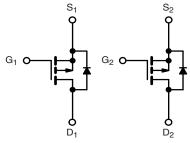
2.05 mm

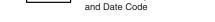
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- 100 % R_a Tested
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

 Load Switch, PA Switch and Battery Switch for Portable Devices and Game Consoles





Lot Traceability

Marking Code

Part # code

Ordering Information: SiA975DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET P-Channel MOSFET

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	- 12	V
Gate-Source Voltage		V_{GS}	± 8	v
	T _C = 25 °C		- 4.5 ^a	
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	,	- 4.5 ^a	
Continuous Diain Current (1) = 150 °C)	T _A = 25 °C	I _D	- 4.5 ^{a,b, c}	
	T _A = 70 °C		- 4.4 ^{b, c}	Α
Pulsed Drain Current		I _{DM}	- 15	
Continuous Source-Drain Diode Current	T _C = 25 °C	l _a	- 4.5 ^a	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 1.6 ^{b, c}	
	T _C = 25 °C		7.8	
Maximum Dawar Dissipation	T _C = 70 °C	В	5	w
Maximum Power Dissipation	T _A = 25 °C	P _D	1.9 ^{b, c}	VV
	T _A = 70 °C		1.2 ^{b, c}	
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature	e) ^{d, e}	Ŭ	260	

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	State R _{thJC} 12.5 16		0/ **					

Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 110 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 12			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 3.6		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i _D = - 250 μA		2.4		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA
Zana Oata Walkana Busin Oamant		V _{DS} = - 12 V, V _{GS} = 0 V			- 1	μА
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 12 V, V _{GS} = 0 V, T _J = 55 °C			- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 10			Α
		V _{GS} = - 4.5 V, I _D = - 4.3 A		0.033	0.041	Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -3.6 \text{ A}$		0.049	0.060	
	, ,	V _{GS} = - 1.8 V, I _D = - 1.5 A		0.070	0.110	
Forward Transconductance ^a	9 _{fs}	V _{DS} = -6 V, I _D = -4.6 A		12		S
Dynamic ^b				-	L	l
Input Capacitance	C _{iss}			1500		pF
Output Capacitance	C _{oss}	V _{DS} = - 6 V, V _{GS} = 0 V, f = 1 MHz		260		
Reverse Transfer Capacitance	C _{rss}			250		
T. 10 . 0		V _{DS} = -6 V, V _{GS} = -8 V, I _D = -5.6 A		17	26	nC
Total Gate Charge	Q_g			10.5	16	
Gate-Source Charge	Q _{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5.6 \text{ A}$		2.3		
Gate-Drain Charge	Q_{gd}			2.5		
Gate Resistance	R_{g}	f = 1 MHz	1.1	5.5	11	Ω
Turn-On Delay Time	t _{d(on)}			22	35	
Rise Time	t _r	$V_{DD} = -6 \text{ V}, R_{L} = 1.3 \Omega$		22	35	- - -
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 4.5 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		32	50	
Fall Time	t _f			15	25	
Turn-On Delay Time	t _{d(on)}			10	15	ns -
Rise Time	t _r	$V_{DD} = -6 \text{ V}, R_{L} = 1.3 \Omega$		10	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 4.5 A, V_{GEN} = - 8 V, R_g = 1 Ω		30	40	
Fall Time	t _f			12	20	
Drain-Source Body Diode Characterist	ics			-	L	l
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.5	
Pulse Diode Forward Current	I _{SM}				- 15	A
Body Diode Voltage	V_{SD}	I _S = - 4.5 A, V _{GS} = 0 V		- 0.87	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			30	60	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1 4 5 4 dl/dt 100 4/:- T 05 00		15	30	nC
Reverse Recovery Fall Time	ta	$I_F = -4.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		15		ns
Reverse Recovery Rise Time	t _b	 		15		

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

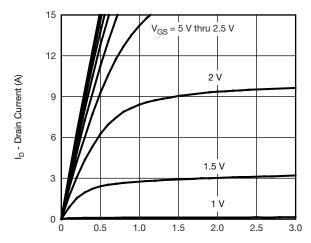
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

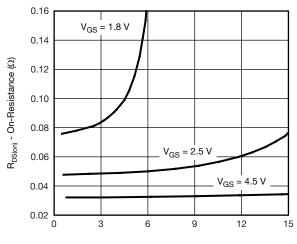


V_{DS} - Drain-to-Source Voltage (V)

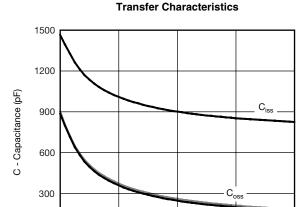
T_C = 25 °C T_C = 125 °C T_C = -55 °C

V_{GS} - Gate-to-Source Voltage (V)

Output Characteristics



I_D - Drain Current (A)

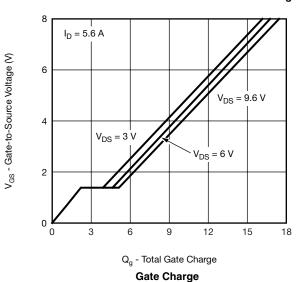


V_{DS} - Drain-to-Source Voltage (V)

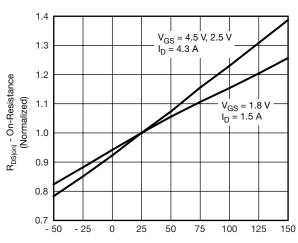
6

 C_{rss}

On-Resistance vs. Drain Current and Gate Voltage



Capacitance



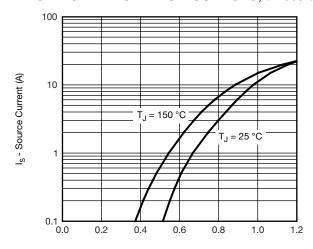
 T_{J} - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

SiA975DJ

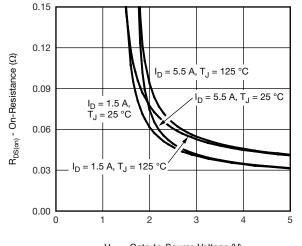
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

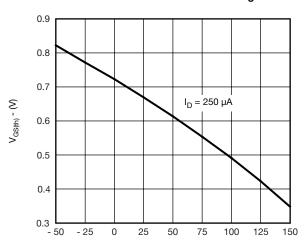


 $\rm V_{SD}$ - Source-to-Drain Voltage (V) **Soure-Drain Diode Forward Voltage**

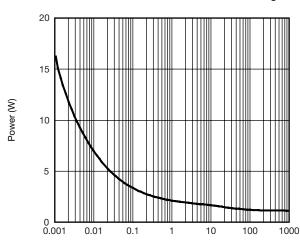


V_{GS} - Gate-to-Source Voltage (V)

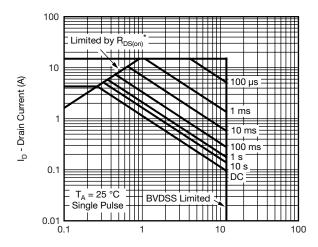
On-Resistance vs. Gate-to-Source Voltage



 T_J - Junction Temperature (°C) **Threshold Voltage**



Time (s)
Single Pulse Power, Junction-to-Ambient



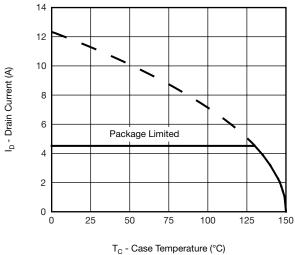
 $\begin{aligned} & V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^*V_{GS} > & \text{minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified} \\ \textbf{Safe Operating Area, Junction-to-Ambient} \end{aligned}$

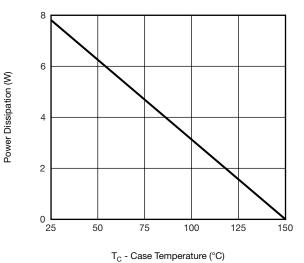




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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Current Derating*

Power Derating

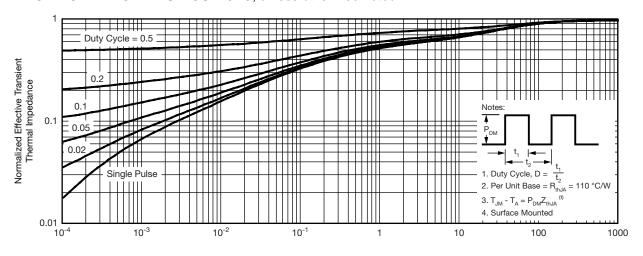
^{*} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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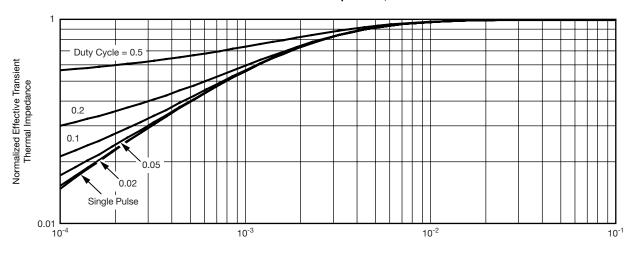


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Square Wave Pulse Duration (s)

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?65710.





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PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

	SINGLE PAD						DUAL PAD					
DIM	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
Е	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC		
K		0.275 TYP 0.011 TYP		0.275 TYP			0.011 TYP					
K1		0.400 TYP 0.016 TYP		0.320 TYP			0.013 TYP					
K2		0.240 TYP 0.009 TYP		0.252 TYP			0.010 TYP					
К3		0.225 TYP 0.009 TYP				•		•	•			
K4		0.355 TYP		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006

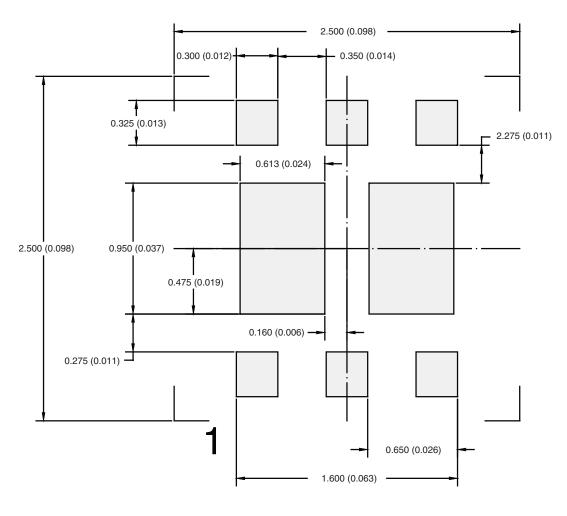
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm/(Inches)

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